

## **FEATURES**

Size Design  $\Phi$ 6.0\*8.0mm

| High Current Handling Capability 10,000A @ 8/20 μs

Low Capacitance and Insertion Loss

| Quick Response and Long Service Life

| Moisture sensitivity level: Level 1



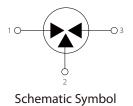
## **APPLICATION INFORMATION**

Communication equipment.

Repeaters, Modems

| Telephone Interface,Line cards.

Data communication equipment.



## **AGENCY APPROVALS**

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
<b>®</b>	Mean lead free		
<i>IR</i> 。	UL Certificated E505857		

## **PRODUCT CHARACTERISTICS**

Lead Material	<b>Body Material</b>	Terminal Finish	
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated	



## **ELECTRICAL PARAMETER**

Parameter	Symbol	Rating	Unit
DC Blocking Voltage 1)	100V/s	640-960	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤1600	V
impuise spark-over voitage	At 1kV/μs	Typical values of distribution ≤1500	V
Impulse Discharge Current 2)	8/20µs	10	KA
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz	V <sub>DC</sub> =0.5V	≤ 2	рЕ
Operating and Storage Temperature		-40~125	°C

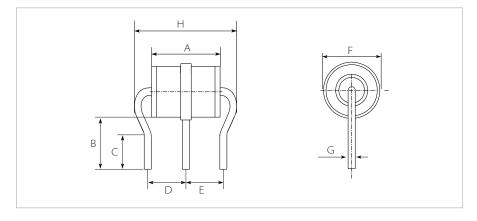
<sup>1)</sup> In ionized mode

## **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards		
High Temperature Storage Test Temperature: 85°C ; Time:2H			
Low Temperature Storage Test	Temperature: -40°C ; Time:2H		
Vibration Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time: 45min			
Resistance of soldering heat	Temperature: 260°C; Time of dip soldering: 10s,1time		

**NOTE:** Up-screen program can be specified by customer's request via contacting Semiware service

## **PRODUCT DIMENSIONS**

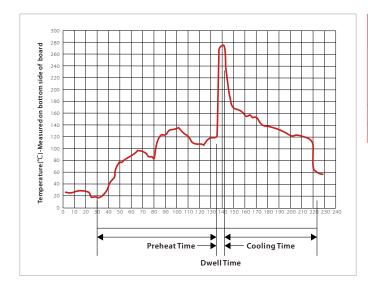


Ref.	Outline Dimensions		
	Millimeters		
А	8.0±0.3		
В	5.0±1.0		
С	3.3±0.3		
D	4.4±0.3		
E	4.4±0.3		
F	Ф6.0±0.2		
G	Ф0.8		
Н	11±1		

<sup>2)</sup> Terms and waveforms in accordance with ITU-T Rec. K. 12; IIEC 61643-311



## **WAVE SOLDERING**



Wave Parameter		Lead-free assembly	
Pre Heat	Temperature Min	100°C	
	Temperature Max	150°C	
	Time(min to max)	60 – 180 secs	
Solder pot Temperature		280°C Max	
Solder Dwell Time		2-5 seconds	

# **ORDERING INFORMATION**

D N		c:			Qty/pcs	ty/pcs	
Part Number	Size	Marking	Tray	Inner Box	Carton		
SG3R0	6B800	Ф6.0*8.0mm	SG3R06B800	100	500	6000	



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### **Complaint & Suggestions**

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### By QR Code





Website

\A/achat

To find your local partner within Semiware's global network: www.semiware.com

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